

2SK3151

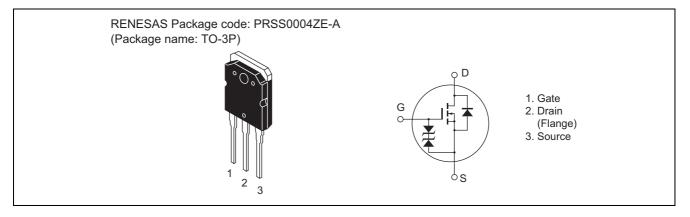
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G1076-0400 (Previous: ADE-208-747B) Rev.4.00 Sep 07, 2005

Features

- Low on-resistance $R_{DS (on)} = 11.5 \text{ m}\Omega \text{ typ.}$
- High speed switching
- 4 V gate drive device can be driven from 5 V source

Outline





Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	100	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	50	A
Drain peak current	I _{D(pulse)} Note1	200	A
Body-drain diode reverse drain current	I _{DR}	50	A
Avalanche current	I _{AP} Note3	50	A
Avalanche energy	E _{AR} ^{Note3}	250	mJ
Channel dissipation	Pch Note2	125	W

150

-55 to +150

°C

°C

Storage temperature

Channel temperature

Notes: 1. PW \leq 10 $\mu s,$ duty cycle \leq 1 %

2. Value at Tc = 25°C

3. Value at Tch = 25°C, Rg \geq 50 Ω

Electrical Characteristics

						$(Ta = 25^{\circ}C)$
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	100	—	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	±20	—	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	—	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	—	10	μΑ	$V_{DS} = 100 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	1.0	—	2.5	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state	R _{DS(on)}	_	11.5	15	mΩ	$I_D = 25 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
resistance	R _{DS(on)}	_	16	25	mΩ	$I_D = 25 \text{ A}, V_{GS} = 4 \text{ V}^{Note4}$
Forward transfer admittance	y _{fs}	30	50	_	S	$I_D = 25 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$
Input capacitance	Ciss	_	4000	_	pF	$V_{DS} = 10 \text{ V}, V_{GS} = 0,$ f = 1 MHz
Output capacitance	Coss	_	1650	_	pF	
Reverse transfer capacitance	Crss		590	_	pF	
Turn-on delay time	t _{d(on)}		30	_	ns	$I_D = 25 \text{ A}, V_{GS} = 10 \text{ V},$
Rise time	tr		280	_	ns	R _L = 1.2 Ω
Turn-off delay time	t _{d(off)}		830	_	ns	
Fall time	t _f	_	450		ns	
Body–drain diode forward voltage	V _{DF}	_	0.95		V	$I_F = 50 \text{ A}, V_{GS} = 0$
Body–drain diode reverse recovery	t _{rr}	_	100	_	V	$I_F = 50 \text{ A}, V_{GS} = 0$
time						di _F / dt = 50 A/ μs

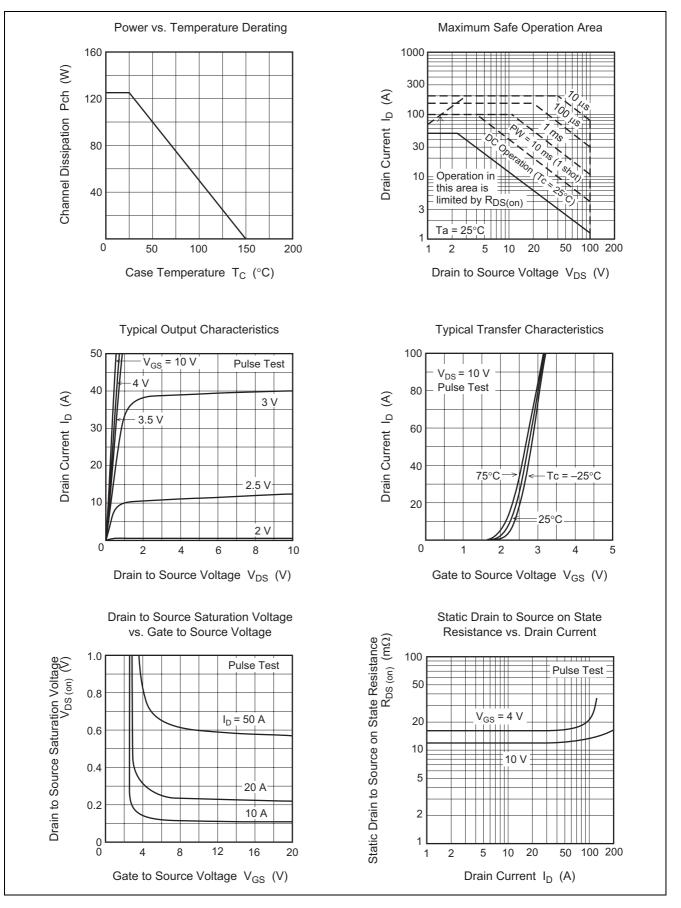
Tch

Tstg

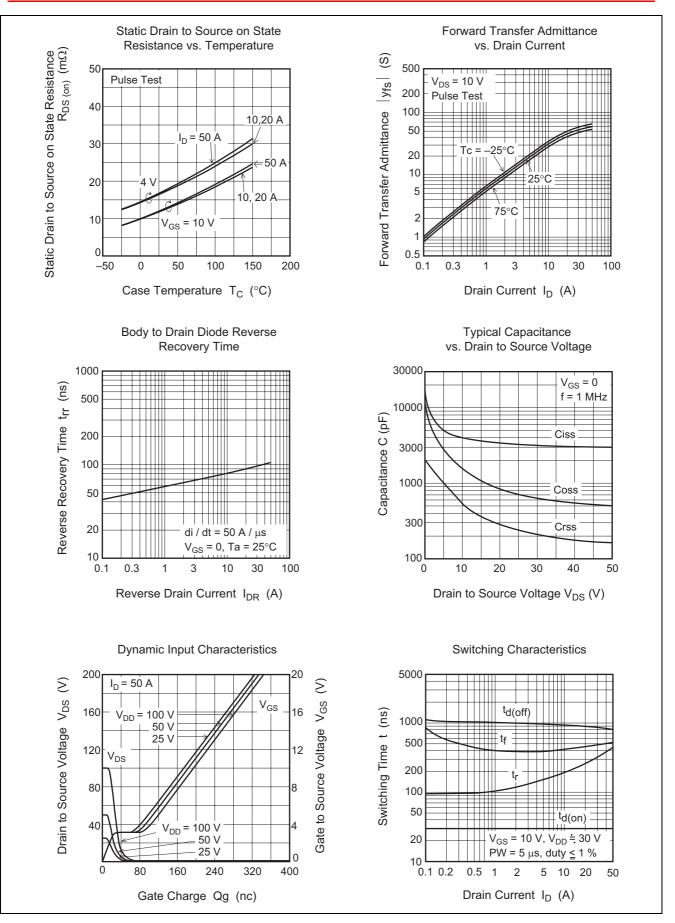
Note: 4. Pulse test



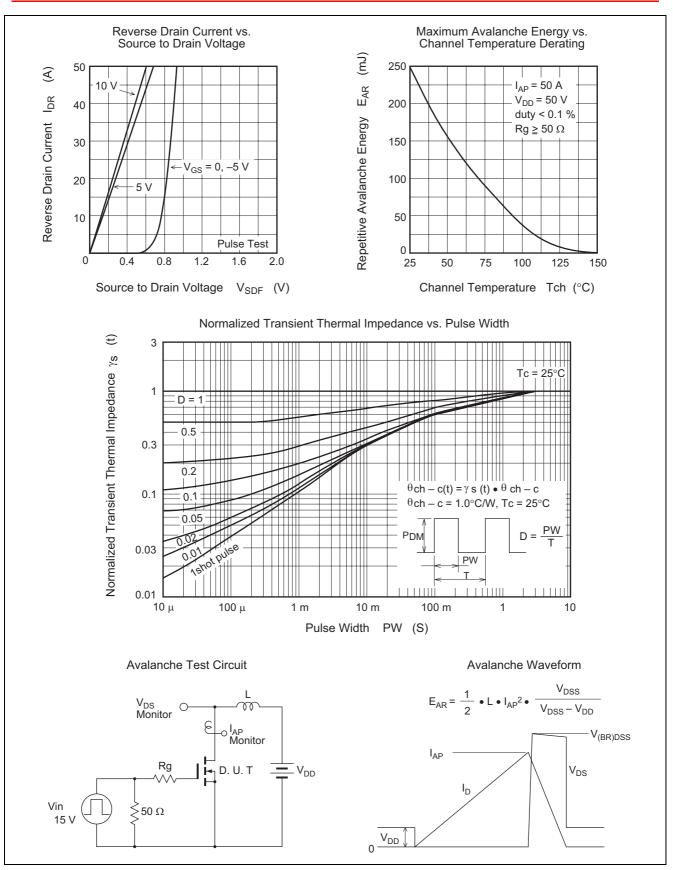
Main Characteristics



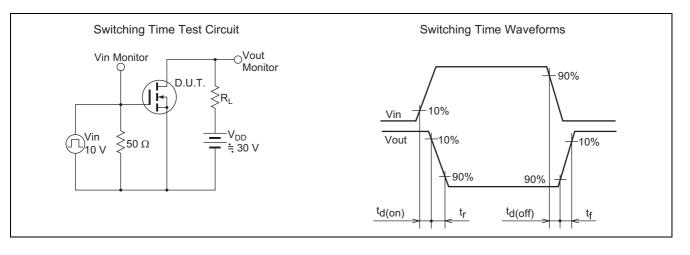






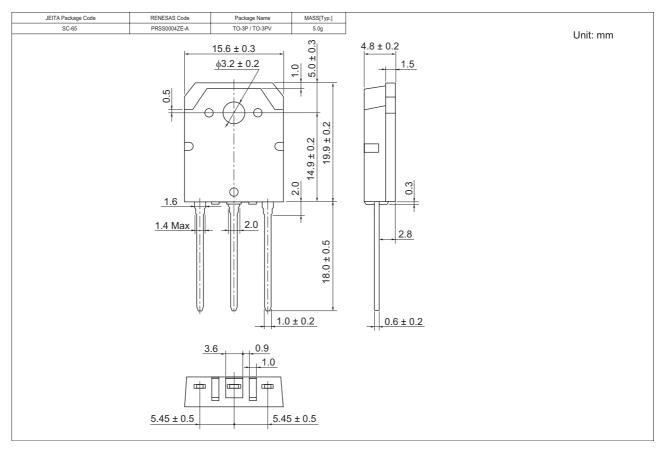








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SK3151-E	30 pcs	Plastic magazine

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